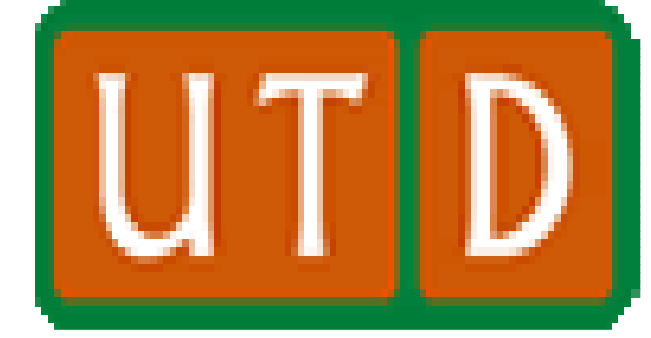


8B 50 MB/s Serial Input Digital to Analog Converter with Analog Comparator

Charles Raymond, Jeremy Bettge & Omar Shankles

chuckr@utdallas.edu, jrb042000@utdallas.edu, oas015000@utdallas.edu

Department of Electrical Engineering
Erik Jonsson School of Engineering & Computer Science
University of Texas at Dallas
Richardson, Texas 75083-0688, U.S.A.

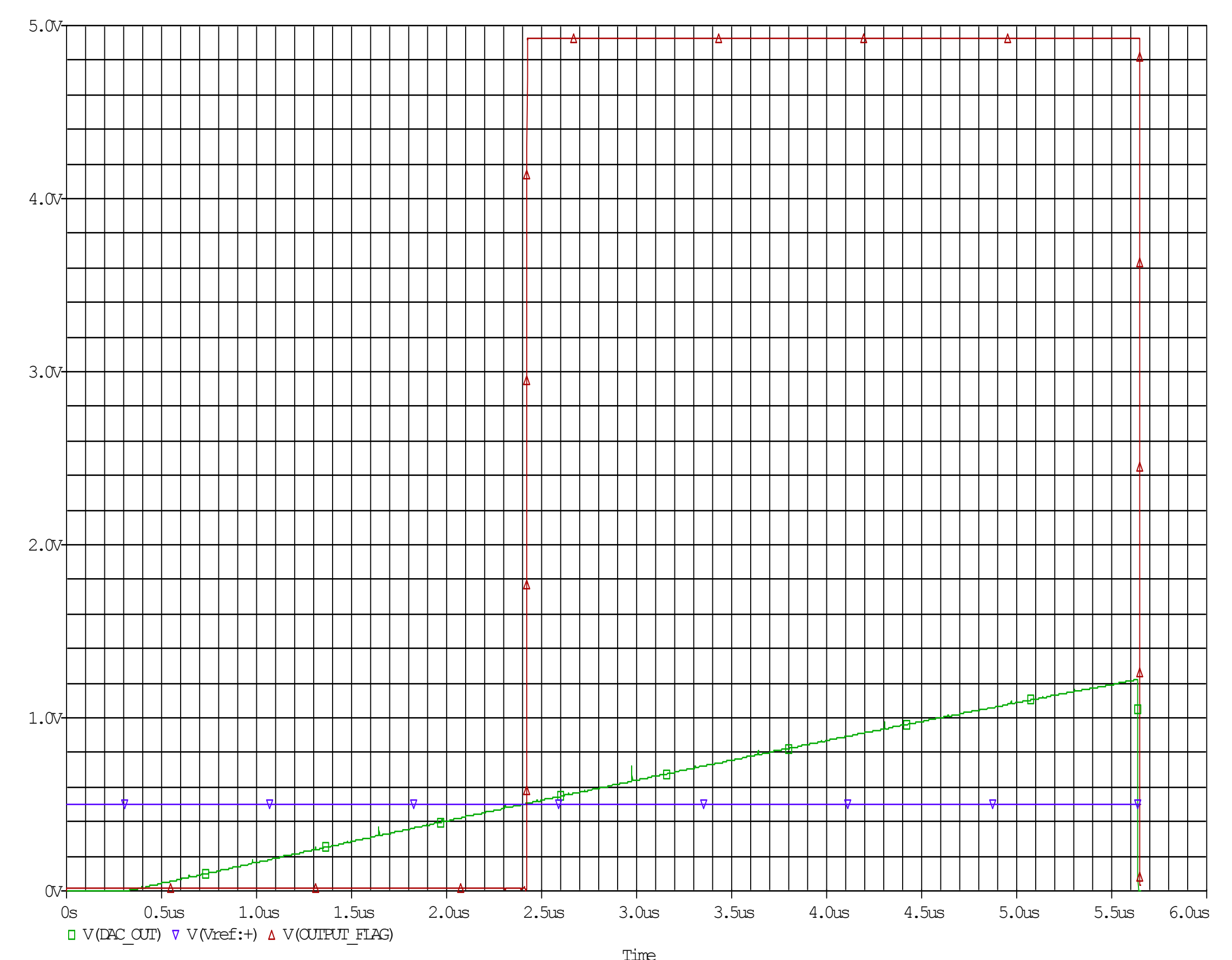


Project Goals:

- ◆ Obtain Serial Input Data
- ◆ Select 8-bits of Data and Pass to DAC at a Speed of 50 MHz
- ◆ Obtain Stable Input Voltage Source for DAC
- ◆ Design a Power on Reset
- ◆ Compare DAC Output Voltage to Reference Voltage
- ◆ Achieve Near-Linear Quantized DAC Output Voltage
- ◆ Achieve Low Power Consumption
- ◆ Understand Deviations from Ideal Components
- ◆ Interpret Graphs and Modify Parts Accordingly
- ◆ Troubleshoot Unexpected Results

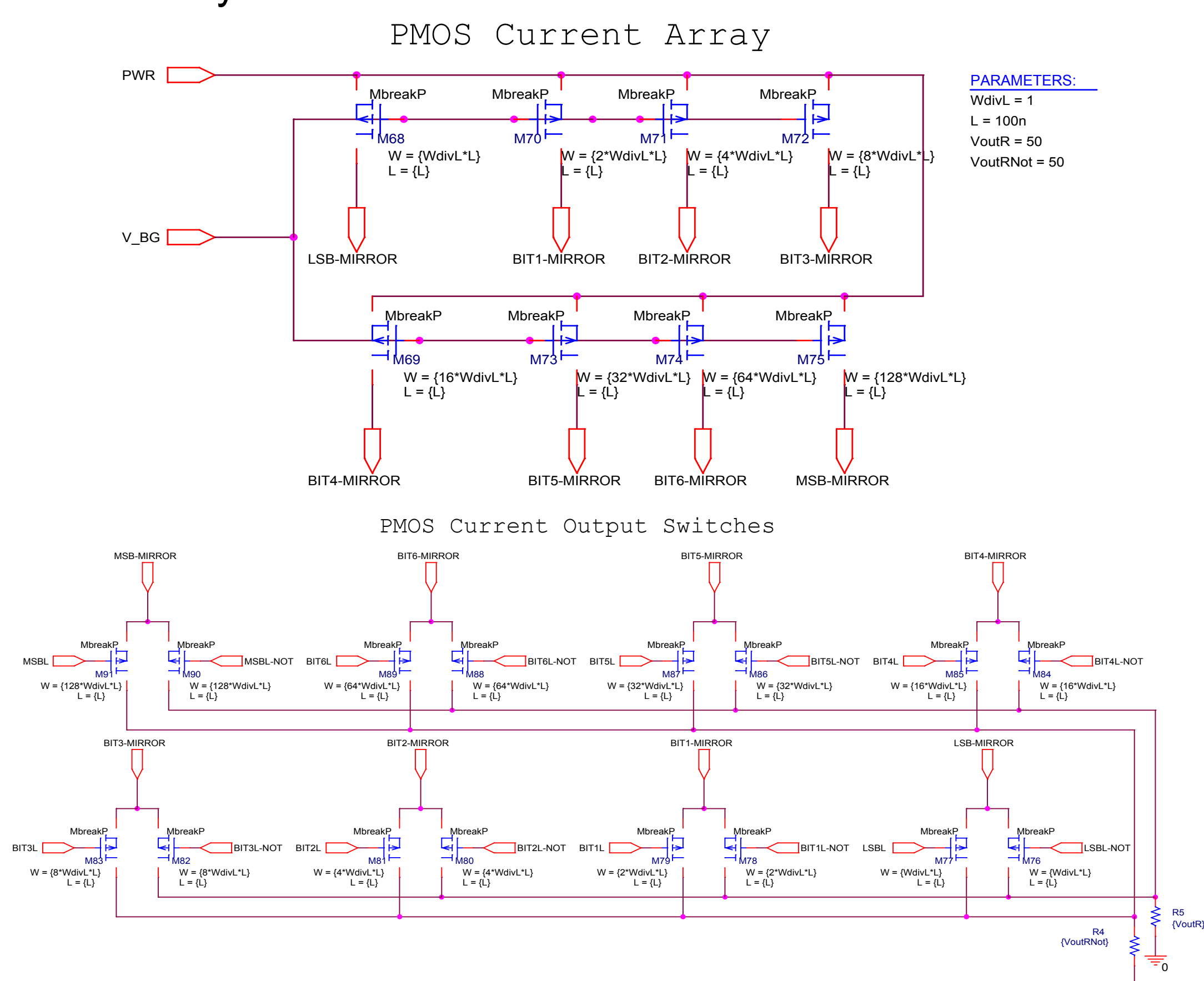
Project Results:

- ◆ The DAC runs at 48.1 MHz instead of 50 MHz due to software limitations
- ◆ Power consumption 5 W
- ◆ Vref = .5 Vdc
- ◆ Vbias = 1.239V
- ◆ Vt = 0.026 eV
- ◆ Minimum length 100nm
- ◆ Minimum width 90 nm
- ◆ Vdd Max = 25 Vdc
- ◆ Temperature sweep from -40°C to 80°C = Vbias change of .04V
- ◆ INLmin = 0
- ◆ INLmax = 5.87 LSB



Project Overview:

- ◆ Research and Design
 - ◆ Determine what component blocks are needed
 - ◆ Select the type of circuit appropriate to each block
- ◆ Proposal
 - ◆ Choose the kind of DAC that will work best for this project
 - ◆ Split up responsibilities for the assembly and testing of each block
- ◆ General Assembly
 - ◆ Define and test simple separate blocks with ideal components
 - ◆ Use as many electronics packages (op-amps, counters, voltage supplies) to facilitate quick circuit implementation
 - ◆ Troubleshoot inconsistencies
- ◆ Implement Full Circuit
 - ◆ Assemble all blocks to form one large circuit
 - ◆ Create separate but connected schematics for major parts
 - ◆ Replace electronic packages with component-level schematics
 - ◆ Notice significant differences from ideal components and select additional components to compensate as necessary
 - ◆ Increasing level of circuit complexity increases possibilities for assembly error



Project Conclusions/Outcomes:

- ◆ Used multiple instances of modified band gap circuit
 - ◆ Simulated other voltage supplies
 - ◆ Decided not to use these circuits; circuits were very time-consuming to design
 - ◆ Decided on instance of band gap with additional hardware to produce desired voltage for DAC current mirrors
- ◆ Implementations that did not work
 - ◆ Both the MOS and BJT op amp models worked ideally with no load. Decided to add another opamp to boost band gap voltage
- ◆ PMOS current array and current output switches are more ideal for architecture than NMOS
- ◆ Binary weighted DAC was not practical and a current steering architecture was more ideal